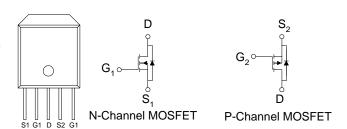
## P & N-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	$r_{DS(on)} m(\Omega)$	$I_{D}(A)$	
30	$95 @ V_{GS} = 2.5V$	20	
30	59	24	
26.5	$178 @ V_{GS} = -2.5V$	-14	
-26.5	$118 @ V_{GS} = -4.5V$	-17	

- $\begin{array}{ll} \bullet & \quad Low \; r_{DS(on)} \; provides \; higher \; efficiency \; and \\ extends \; battery \; life \\ \end{array}$
- Low thermal impedance copper leadframe DPAK saves board space
- Fast switching speed
- High performance trench technology



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	N-Channel	P-Channel	Units	
Drain-Source Voltage		$V_{DS}$	30	-26.5	V	
Gate-Source Voltage		$V_{GS}$	±12	±12		
Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}C$	$I_D$	24	-17	Α	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	40	-40	A	
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	30	-30	Α	
Power Dissipation <sup>a</sup>	$T_A=25^{\circ}C$	$P_{D}$	50	50	W	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to	°C		

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Maximum	Units	
Maximum Junction-to-Ambient <sup>a</sup>	$R_{ heta JA}$	50	°C/W	
Maximum Junction-to-Case	$R_{ heta JC}$	3.0	°C/W	

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## Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

AMD532C

SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Conditions	Limits				Unit
	бушбог	103t Conditions	Ch	Min	Тур	Max	Cint
Static							
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}$ , $I_D = 250 \text{ uA}$	N	0.6		-	V
	(- /	$V_{GS} = V_{DS}, I_{D} = -250 \text{ uA}$ $V_{GS} = -12 \text{ V}, V_{DS} = 0 \text{ V}$	P P	-0.6		±100	
Gate-Body Leakage	$I_{GSS}$	$V_{GS} = 12 \text{ V}, V_{DS} = 0 \text{ V}$	N			±100	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$	P			-1	uA
Zero Gate Voltage Drain Current	-DSS	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	N	20		1	uД
On-State Drain Current <sup>A</sup>	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	N P	20 -20		ļ	Α
	1	$v_{DS} = -3 \text{ V}, v_{GS} = -4.3 \text{ V}$ VGS = 4.5  V, ID = 5.0  A		-20		59	
D : C O D : A		VGS = 2.5 V, ID = 4.2 A	N			95	mΩ
Drain-Source On-Resistance <sup>A</sup>	r <sub>DS(on)</sub>	$VGS = -4.5 \text{ V}, I_D = -3.6 \text{ A}$	Р			112	
		$VGS = -2.5 \text{ V}, I_D = -2.9 \text{ A}$	•			172	
Forward Tranconductance <sup>A</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_{D} = 5.0 \text{ A}$	N		25		S
	<b>C</b> 13	$V_{DS} = -15 \text{ V}, I_{D} = -3.6 \text{ A}$	P		10		
Dynamic							
Total Gate Charge	$Q_{g}$	N-Channel	N P		6.3		
	-	$V_{DS}$ =15V, $V_{GS}$ =4.5V, $I_{D}$ =5.0A	N		0.9		ł
Gate-Source Charge	$Q_{gs}$	$v_{DS}^{-13}v$ , $v_{GS}^{-4.3}v$ , $v_{D}^{-3.0}A$	P		2.2		nC
C + D : C	0.	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3.6A	N		1.9		
Gate-Drain Charge	Qgd		P		1.7		
Switching							
Turn-On Delay Time	f.()	N. Cl.	N		7.4		
Turn-On Delay Time	td(on)	N-Chaneel	P		7.6		
Rise Time	$t_{\rm r}$	$V_{DD}$ =15V, $V_{GS}$ =4.5V, $I_{D}$ =1A , $R_{GEN}$ =6 $\Omega$ ,	N P		6.8	1	
		P-Channel	N		22.2		nS
Turn-Off Delay Time	td(off)	VDD=-15V, VGS=-4.5V, ID=-1A	P		33.6		
Fall-Time	$t_{\mathrm{f}}$	$R_{GEN}=6\Omega$	N		3.6		
Tan-1 line			P		23.2		

## Notes

- a. Pulse test:  $PW \le 300us duty cycle \le 2\%$ .
- b. Guaranteed by design, not subject to production testing.

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